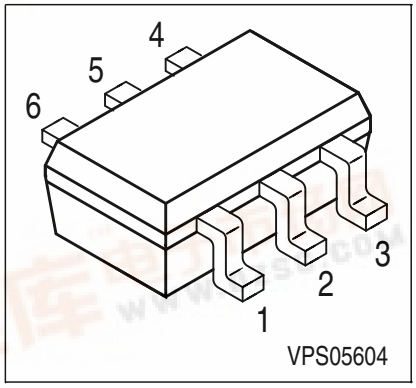
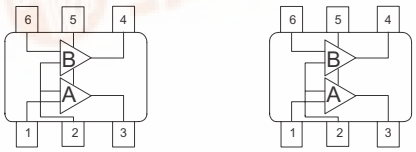
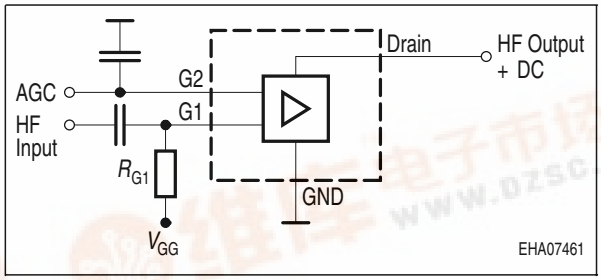
DUAL N-Channel MOSFET Tetrode



- Two gain controlled input stages for UHF and VHF -tuners e.g. (NTSC, PAL)
- Optimized for UHF (amp. B) and VHF (amp. A)
- Integrated gate protection diodes
- High AGC-range, low noise figure, high gain
- Improved cross modulation at gain reduction

BG3123 **BG3123R**





ESD: **E**lectro**s**tatic **d**ischarge sensitive device, observe handling precaution!

Type	Package	Pin Configuration						Marking
BG3123	SOT363	1=G1*	2=G2	3=D*	4=D**	5=S	6=G1**	KOs
BG3123R***	SOT363	1=G1**	2=S	3=D**	4=D*	5=G2	6=G1*	KRs

* For amp. A; ** for amp. B

*** Target Data
180° rotated tape loading orientation available

Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-source voltage	V_{DS}	8	V
Continuous drain current	I_D		mA
amp. A		25	
amp. B		20	
Gate 1/ gate 2-source current	$\pm I_{G1/2SM}$	1	
Gate 1/ gate 2-source voltage	$\pm V_{G1/G2S}$	6	V
Total power dissipation	P_{tot}	200	mW
Storage temperature	T_{stg}	-55 ... 150	°C
Channel temperature	T_{ch}	150	

Thermal Resistance

Parameter	Symbol	Value	Unit
Channel - soldering point[1)]	R_{thchs}	≤ 150	K/W

Electrical Characteristics

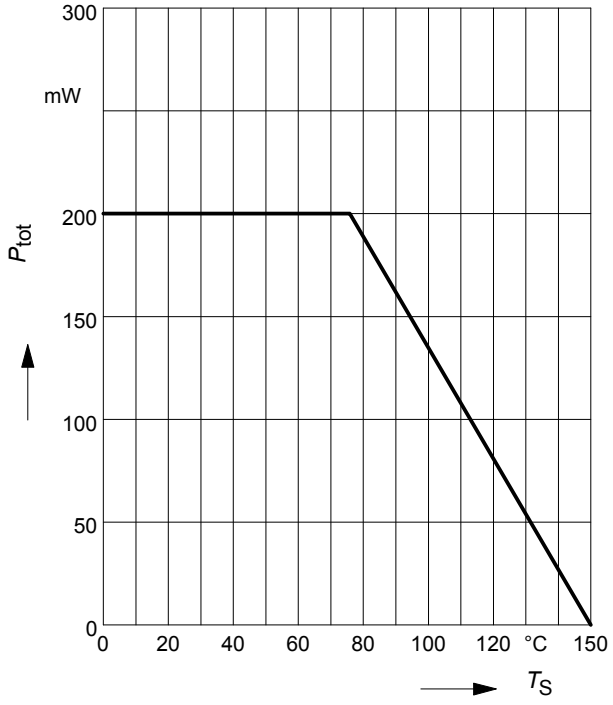
Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics					
Drain-source breakdown voltage I_D = 10 µA, V_{G1S} = 0 V, V_{G2S} = 0 V	$V_{(BR)DS}$	12	-	-	V
Gate1-source breakdown voltage +I_{G1S} = 10 mA, V_{G2S} = 0 V, V_{DS} = 0 V	+$V_{(BR)G1SS}$	6	-	15	
Gate2-source breakdown voltage +I_{G2S} = 10 mA, V_{G1S} = 0 V, V_{DS} = 0 V	+$V_{(BR)G2SS}$	6	-	15	
Gate1-source leakage current V_{G1S} = 6 V, V_{G2S} = 0 V	+I_{G1SS}	-	-	50	µA
Gate2-source leakage current V_{G2S} = 8 V, V_{G1S} = 0 V, V_{DS} = 0 V	+I_{G2SS}	-	-	50	nA
Drain current V_{DS} = 5 V, V_{G1S} = 0 V, V_{G2S} = 4.5 V	I_{DSS}	-	-	10	µA
Drain-source current V_{DS} = 5 V, V_{G2S} = 4 V, R_{G1} = 60 kΩ, amp. A V_{DS} = 5 V, V_{G2S} = 4 V, R_{G1} = 50 kΩ, amp. B	I_{DSX}	 - -	 14 14	 - -	mA
Gate1-source pinch-off voltage V_{DS} = 5 V, V_{G2S} = 4 V, I_D = 20 µA	$V_{G1S(p)}$	-	0.7	-	V
Gate2-source pinch-off voltage V_{DS} = 5 V, I_D = 20 µA	$V_{G2S(p)}$	-	0.6	-	

[1]For calculation of R_{thJA} please refer to Application Note Thermal Resistance

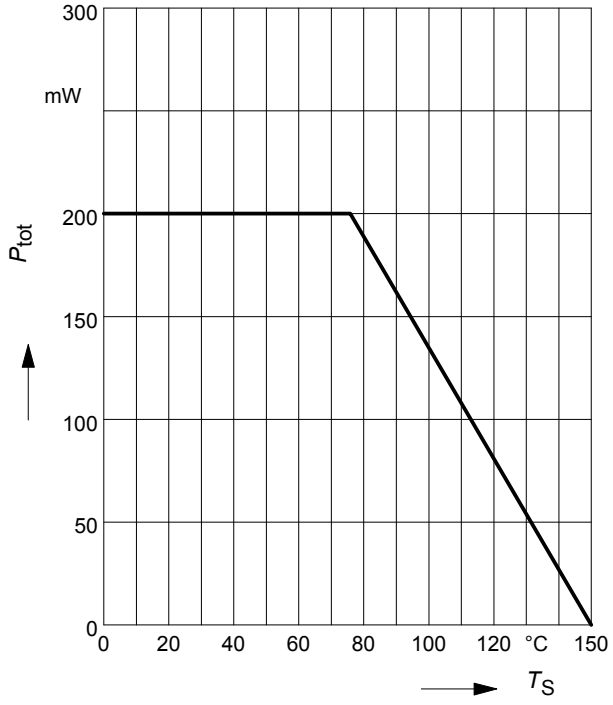
Electrical Characteristics

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
AC Characteristics V_{DS} = 5V, V_{G2S} = 4V, (I_D = 14 mA) (verified by random sampling)					
Forward transconductance	g_{fs}				mS
amp. A		-	30	-	
amp. B		-	25	-	
Gate1 input capacitance	C_{g1ss}				pF
f = 10 MHz, amp. A		-	1.9	-	
f = 10 MHz, amp. B		-	1.5	-	
Output capacitance	C_{dss}				
f = 10 MHz, amp. A		-	1.3	-	
f = 10 MHz, amp. B		-	1.1	-	
Power gain	G_p				dB
f = 800 MHz, amp. A		-	25	-	
f = 800 MHz, amp. B		-	24	-	
f = 45 MHz, amp. A		-	32	-	
f = 45 MHz, amp. B		-	30	-	
Noise figure	F				dB
f = 800 MHz, amp. A		-	1.8	-	
f = 800 MHz, amp. B		-	1.8	-	
f = 45 MHz, amp. A		-	1.4	-	
f = 45 MHz, amp. B		-	1.6	-	
Gain control range	ΔG_p	45	-	-	
V_{G2S} = 4 ... 0 V , f = 800 MHz					
Cross-modulation k=1%, f_w=50MHz, f_{unw}=60MHz	X_{mod}				-
amp.A , AGC = 0 dB		90	96	-	
amp. B, AGC = 0 dB		90	97	-	
amp. A , AGC = 10 dB		-	91	-	
amp. B , AGC = 10 dB		-	94	-	
amp. A, AGC = 40 dB		98	103	-	
amp. B, AGC = 40 dB		98	104	-	

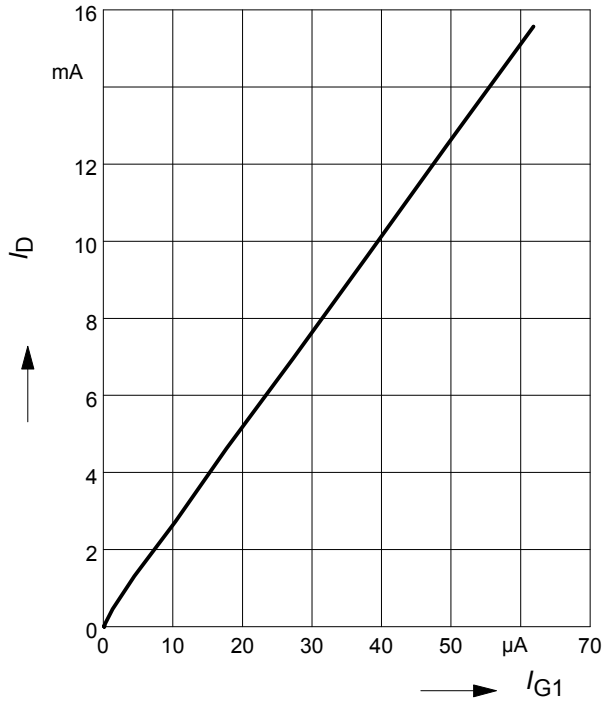
Total power dissipation $P_{tot} = f(T_S)$
amp. A



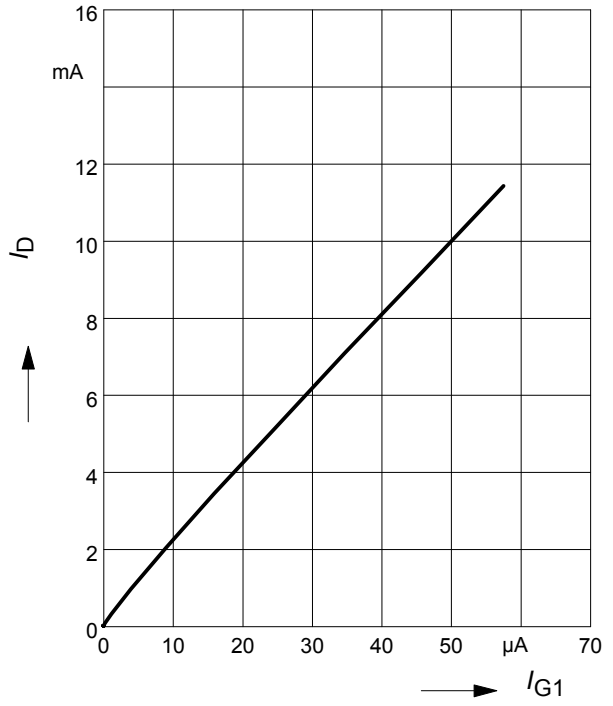
Total power dissipation $P_{tot} = f(T_S)$
amp. B



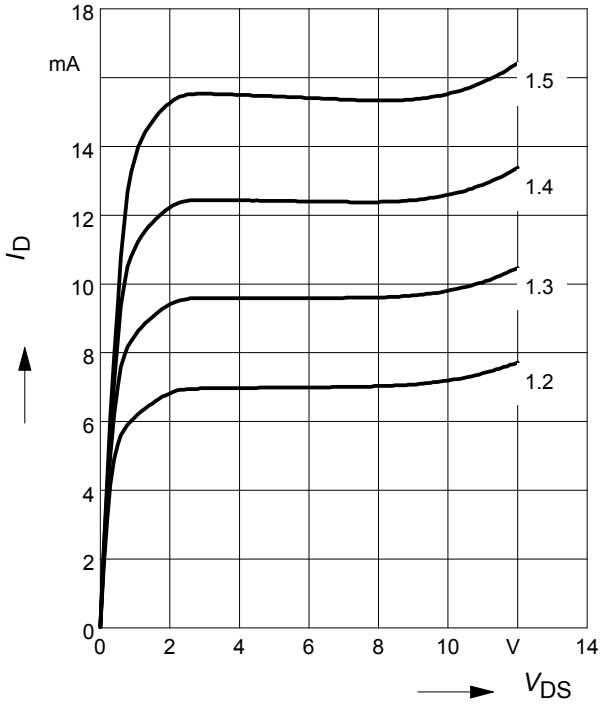
Drain current $I_D = f(I_{G1})$
V_{G2S} = 4V
amp. A



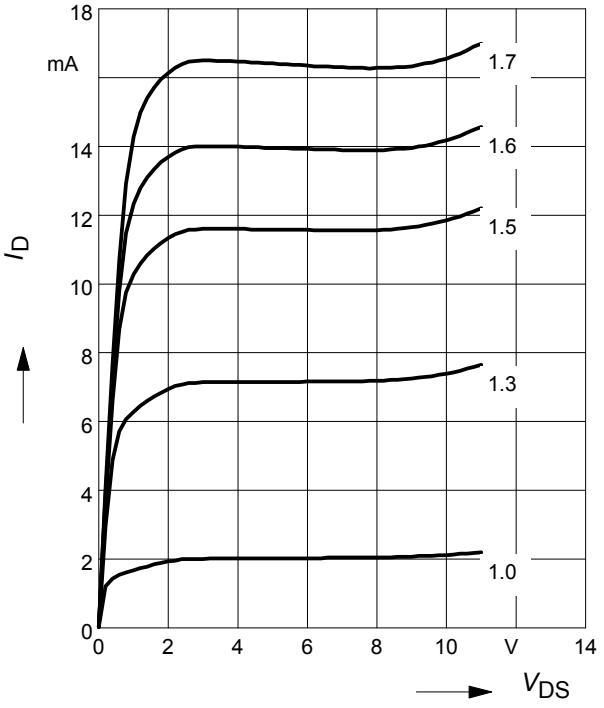
Drain current $I_D = f(I_{G1})$
V_{G2S} = 4V
amp. B



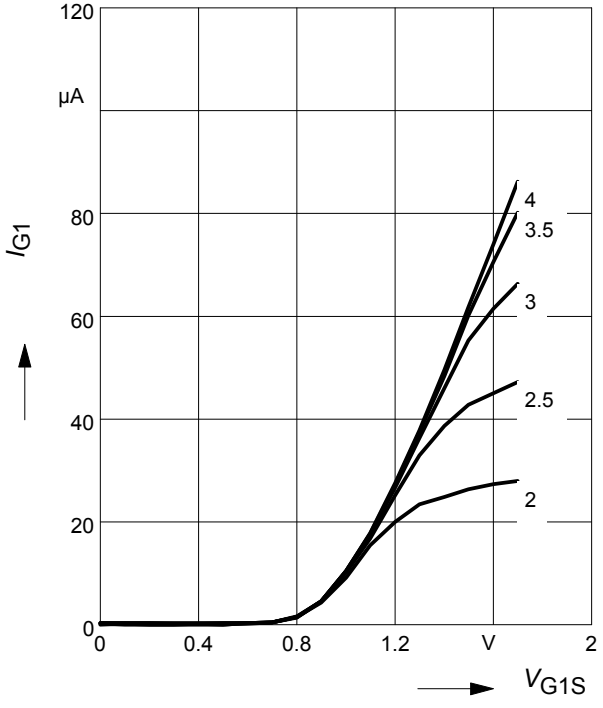
Output characteristics $I_D = f(V_{DS})$
V_{G2S} = 4V, V_{G1S} = Parameter in V
amp. A



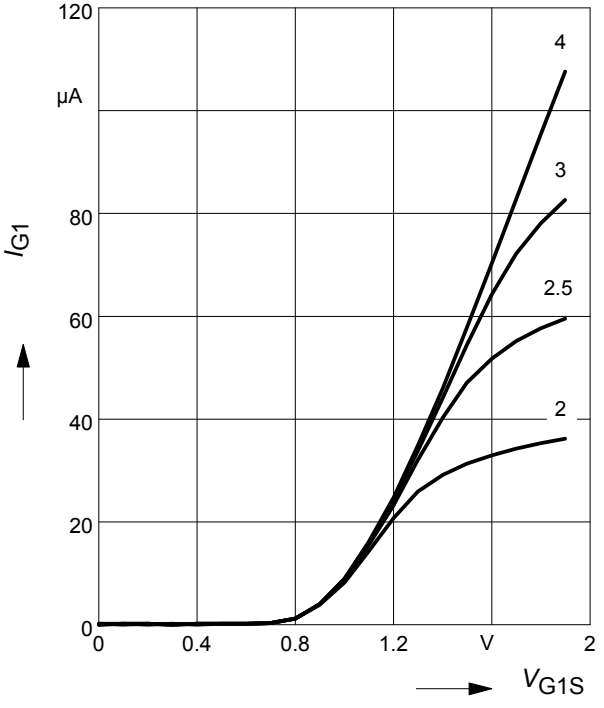
Output characteristics $I_D = f(V_{DS})$
V_{G2S} = 4V, V_{G1S} = Parameter in V
amp. B



Gate 1 current $I_{G1} = f(V_{G1S})$
V_{DS} = 5V, V_{G2S} = Parameter in V
amp. A



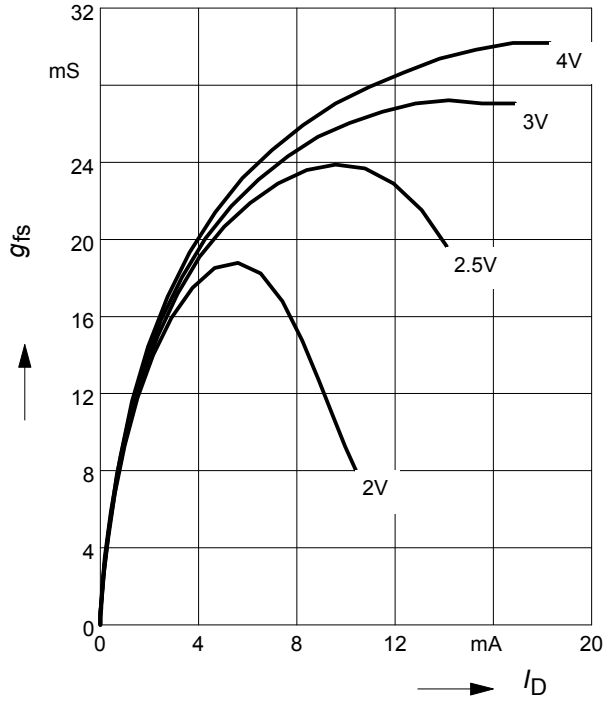
Gate 1 current $I_{G1} = f(V_{G1S})$
V_{DS} = 5V, V_{G2S} = Parameter in V
amp. B



Gate 1 forward transconductance

g_{fs} = $f(I_D)$, V_{DS} = 5V, V_{G2S} = Parameter

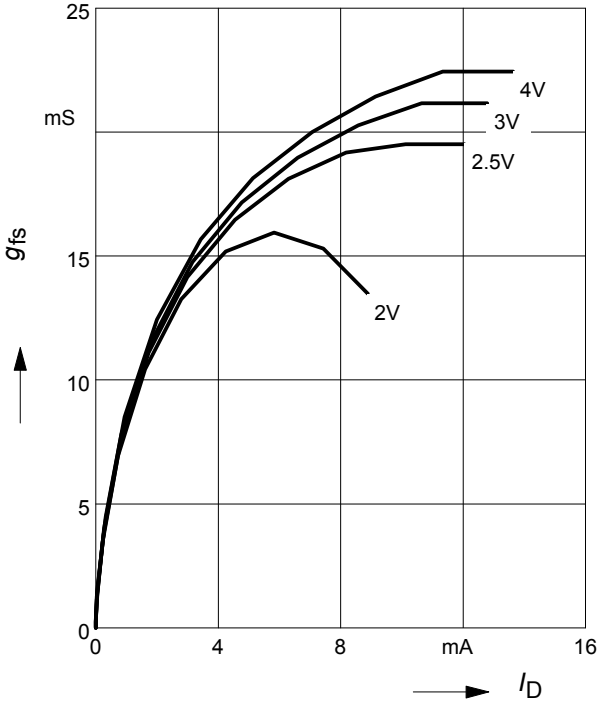
amp. A



Gate 1 forward transconductance

g_{fs} = $f(I_D)$, V_{DS} = 5V, V_{G2S} = Parameter

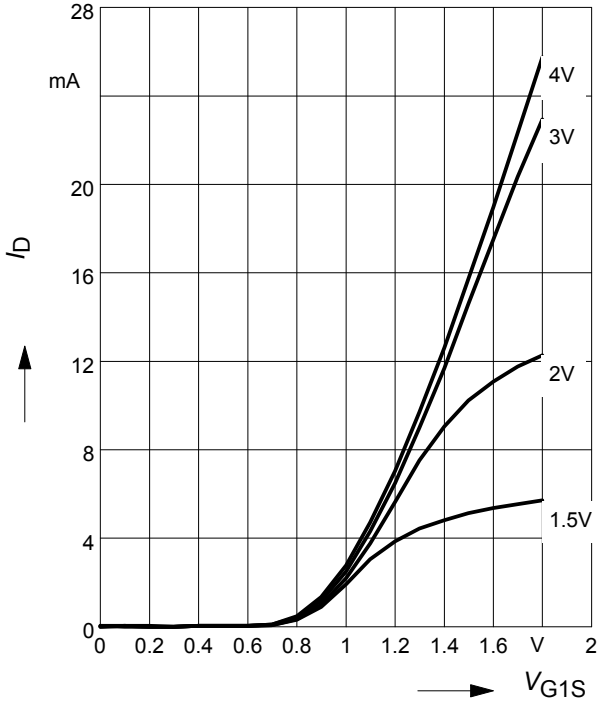
amp. B



Drain current I_D = $f(V_{G1S})$

V_{DS} = 5V, V_{G2S} = Parameter

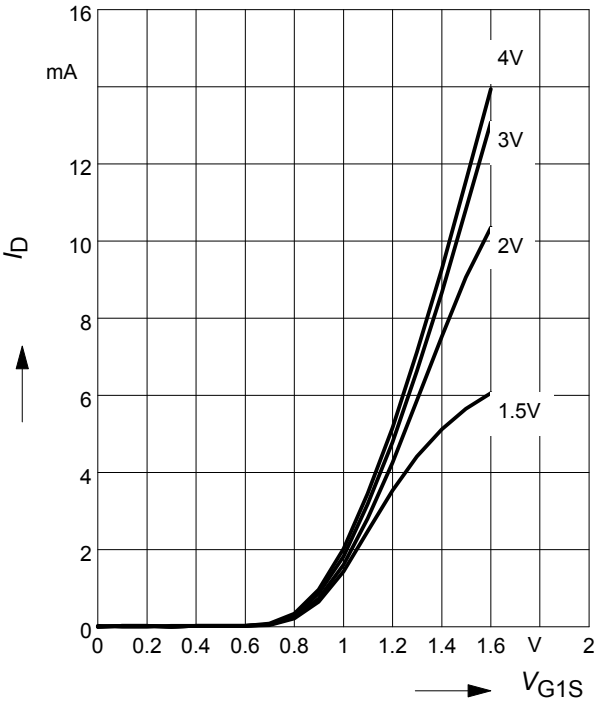
amp. A



Drain current I_D = $f(V_{G1S})$

V_{DS} = 5V, V_{G2S} = Parameter

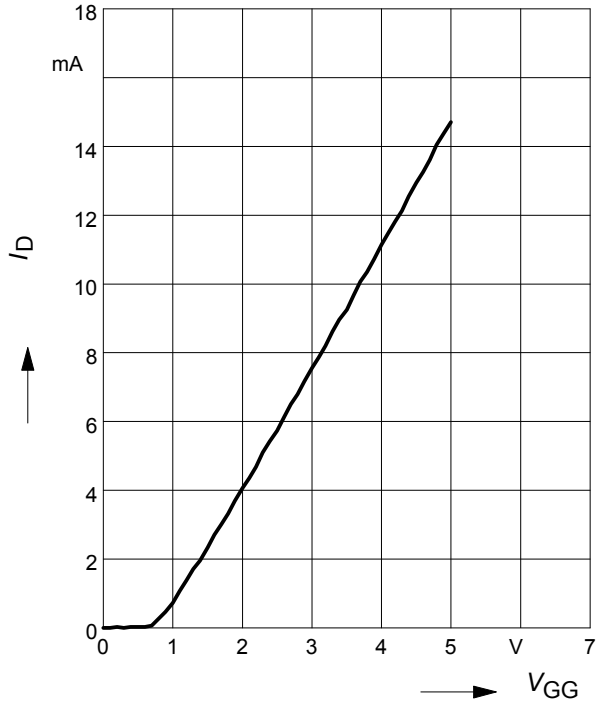
amp. B



Drain current $I_D = f(V_{GG})$ amp. A

V_{DS} = 5V, V_{G2S} = 4V, R_{G1} = 60kΩ

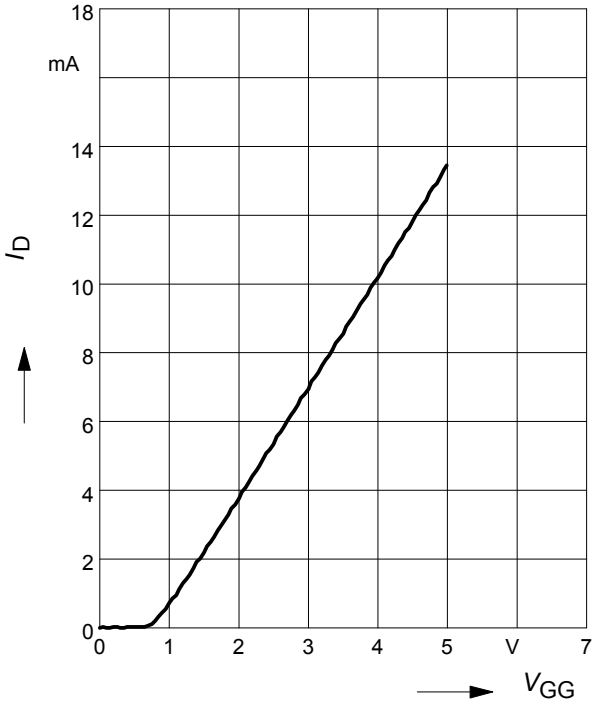
(connected to V_{GG}, V_{GG}=gate1 supply voltage)



Drain current $I_D = f(V_{GG})$ amp. B

V_{DS} = 5V, V_{G2S} = 4V, R_{G1} = 50kΩ

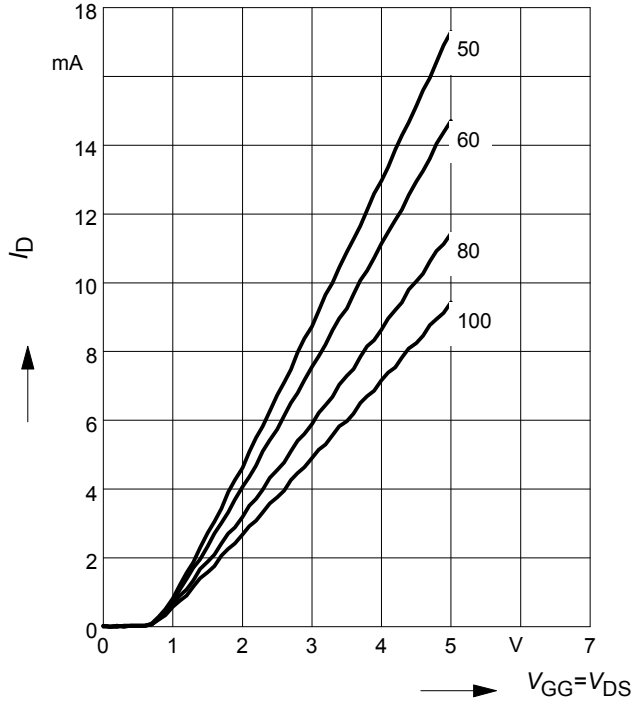
(connected to V_{GG}, V_{GG}=gate1 supply voltage)



Drain current $I_D = f(V_{GG})$

V_{G2S} = 4V, R_{G1} = Parameter in kΩ

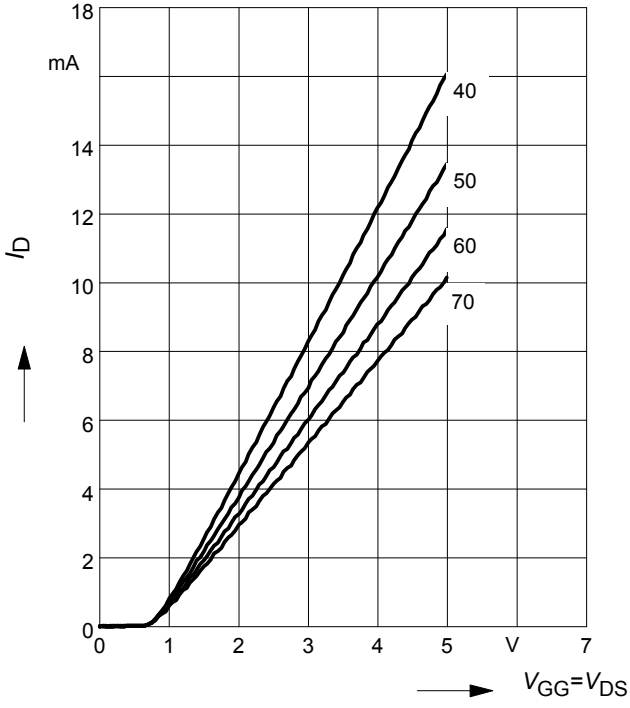
amp. A



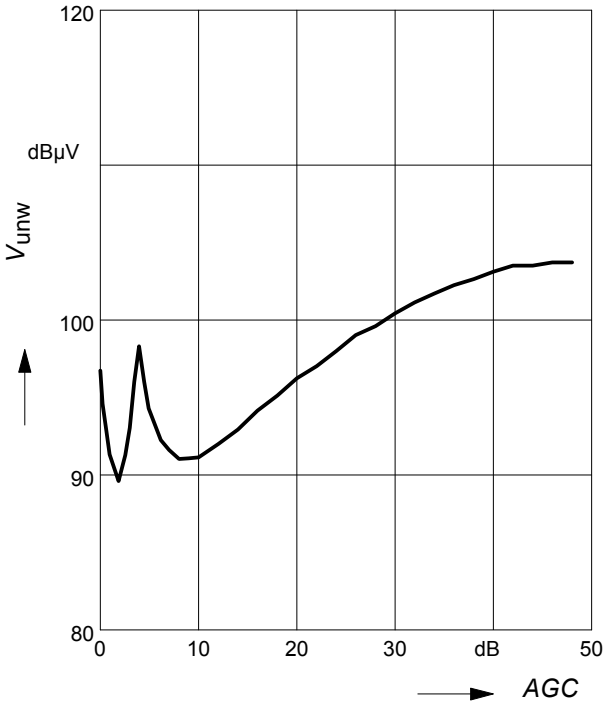
Drain current $I_D = f(V_{GG})$

V_{G2S} = 4V, R_{G1} = Parameter in kΩ

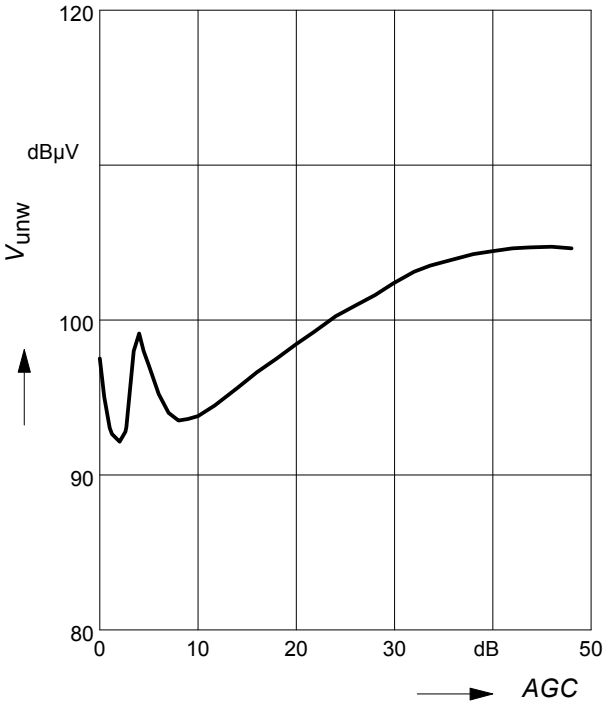
amp. B



Crossmodulation V_{unw} = (*AGC*)
V_{DS} = 5 V, R_{g1} = 68 kΩ
amp.A



Crossmodulation V_{unw} = (*AGC*)
V_{DS} = 5 V, R_{g1} = 56 kΩ
amp.B



Cossmodulation test circuit